

Electronic supplementary information

Hemiaminal Dynamic Covalent Networks with Rapid Stress Relaxation, Reprocessability and Degradability Endowed by the Synergy of Disulfide and Hemiaminal Bonds

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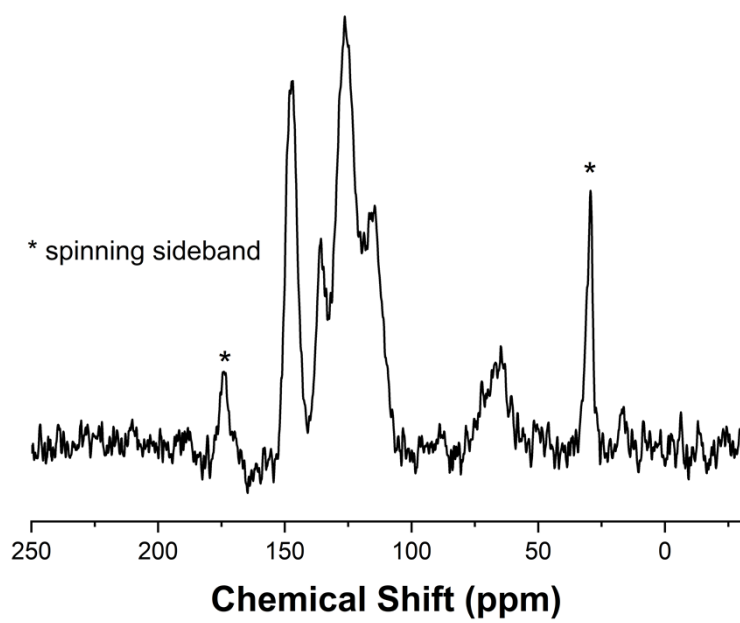


Fig. S1 Solid state ^{13}C NMR spectrum of HDCN-DTDA.

Table S1 A comparison of reprocessing temperatures, reprocessing times and degradation conditions between HDCNs-DTDA and reported vitrimers containing single disulfide or hemiaminal bonds

Polymer type	Dynamic bond	Reprocessing temperature (°C)	Reprocessing time (min)	Degraded condition	Ref.
HDCNs	Hemiaminal bond	140	30	Amine solution	1
HDCNs	Hemiaminal bond	-	-	Sulfuric acid solution	2
HDCNs	Hemiaminal bond	-	-	Sulfuric acid solution	3
HDCNs	Hemiaminal bond	-	-	Hydrochloric acid solution	4
Epoxy resin	Disulfide bond	155	120	Tributylphosphine solvent	5
Epoxy resin	Disulfide bond	180	60	Thiol solution	6
HDCNs	Hemiaminal and disulfide bonds	130	10	Thiol solution and hydrochloric acid solution	This work

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